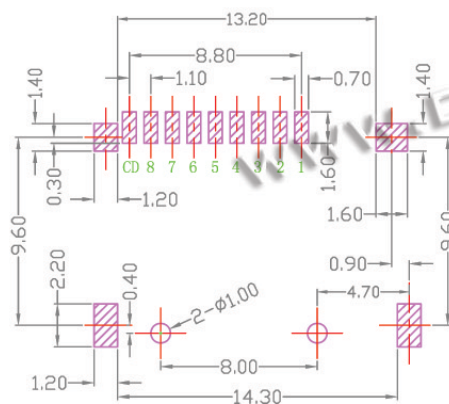
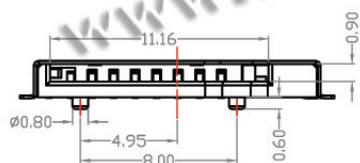
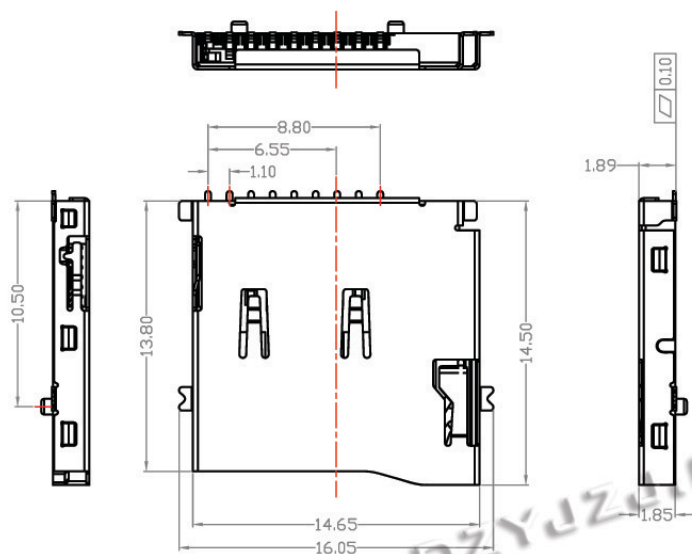




PIN NO.	NAME	YTYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)

1.MATERIAL:

1.1 INSULATOR: LCP+30%GF, UL94V-0; COLOR: BLACK.

1.2 SLIDE: LCP+30%GF, UL94V-0; COLOR: BLACK.

1.3 CONTACT: CS191R-EH, T=0.15mm

1.4 SHELL: SUS304 1/2H, T=0.15mm

2.FINISH:

2.1 CONTACT: GOLD FLASH PLATED IN CONTACT AREA ;
100 μ MIN. TIN PLATED IN SOLDER AREA
50 μ MIN. NICKEL UNDERPLATED OVERALL.2.2 SHELL: 50 μ MIN. NICKEL PLATED OVERALL,
AND GOLD FLASH PLATED IN SOLDER AREA

3.ELECTRICAL CHARACTERISTICS

3.1 CURRENT RATING: AC/DC 0.5A.

3.2 OPERATING VOLTAGE: 100V AC(RMS)/DC

3.2 CONTACT RESISTANCE: 100m Ω MAX.3.3 INSULATION RESISTANCE: 1000M Ω MIN DC 250VDC.

3.4 DIELECTRIC WITHSTANDING VOLTAGE: AC 500V PER MINUTE.

3.5 OPERATING TEMPERATURE: -25 $^{\circ}$ C ~ +85 $^{\circ}$ C.

4.NOTES:

4.1 THIS COMPONENT AND ITS HOMOGENEOUS SUBCOMPONENTS
ARE RoHS COMPLIANT.4.2 RESISTANCE TO SOLDERING HEAT: 260 $\pm$ 5 $^{\circ}$ C FOR 10 SECONDS.

4.3 COPLANARITY IS 0.1MM MAX



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TOLERANCE:

X.X ± 0.30 X.XX ± 0.25 X.XXX ± 0.15 X' $\pm 2'$ X.X' $\pm 0.5'$ 

UNIT: mm [inch]

SCALE: 1:1 SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

TF PUSH 外悍双压片

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

HYC70-TF09-185

APPROVED BY:

邱国夷

DATE :

2014-02-23

DRAW NO:

HYC-TF16060309

SHEET NO.

1 OF 1